

## SMALL SIGNAL SCHOTTKY DIODE

**Table 1: Main Product Characteristics**

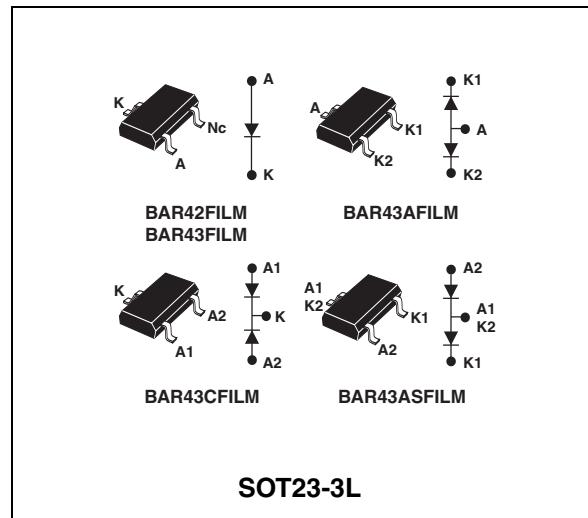
$I_{F(AV)}$	0.1 A
$V_{RRM}$	30 V
$T_j$	150°C
$V_F(\max)$	0.33 and 0.40 V

### FEATURES AND BENEFITS

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount device

### DESCRIPTION

General purpose metal to silicon diodes featuring very low turn-on voltage and fast switching.



**Table 2: Order Codes**

Part Number	Marking
BAR42FILM	D94
BAR43FILM	D95
BAR43AFILM	DB1
BAR43CFILM	DB2
BAR43SFILM	DA5

**Table 3: Absolute Ratings (limiting values)**

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		30	V
$I_{F(AV)}$	Continuous forward current		0.1	A
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ms sinusoidal}$	0.75	A
$P_{tot}$	Power dissipation (note 1)	$T_{amb} = 25^\circ\text{C}$	250	mW
$T_{stg}$	Maximum storage temperature range		-65 to + 150	°C
$T_j$	Maximum operating junction temperature *		150	°C
$T_L$	Maximum temperature for soldering during 10s		260	°C

Note 1: for double diodes,  $P_{tot}$  is the total dissipation of both diodes.

\* :  $\frac{dP_{tot}}{dT_j} > \frac{1}{R_{th}(j-a)}$  thermal runaway condition for a diode on its own heatsink

## BAR42FILM / BAR43FILM

**Table 4: Thermal Resistance**

Symbol	Parameter	Value	Unit
R <sub>th(j-a)</sub>	Junction to ambient (*)	500	°C/W

(\*) Mounted on epoxy board with recommended pad layout.

**Table 5: Static Electrical Characteristics**

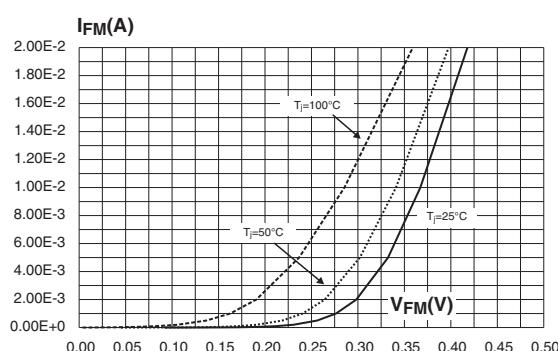
Symbol	Parameter	Tests conditions		Min.	Typ	Max.	Unit
V <sub>BR</sub>	Breakdown voltage	T <sub>j</sub> = 25°C	I <sub>R</sub> = 100µA	30			V
I <sub>R</sub> *	Reverse leakage current	T <sub>j</sub> = 25°C	V <sub>R</sub> = V <sub>RRM</sub>			500	nA
		T <sub>j</sub> = 100°C				100	µA
V <sub>F</sub> **	Forward voltage drop	T <sub>j</sub> = 25°C	BAR42	I <sub>F</sub> = 10mA		0.35	0.40
				I <sub>F</sub> = 50mA		0.50	0.65
			BAR43	I <sub>F</sub> = 2mA	0.26		0.33
				I <sub>F</sub> = 15mA			0.45
			ALL	I <sub>F</sub> = 100mA			1

Pulse test:  
\* tp = 5 ms,  $\delta < 2\%$   
\*\* tp = 380 µs,  $\delta < 2\%$

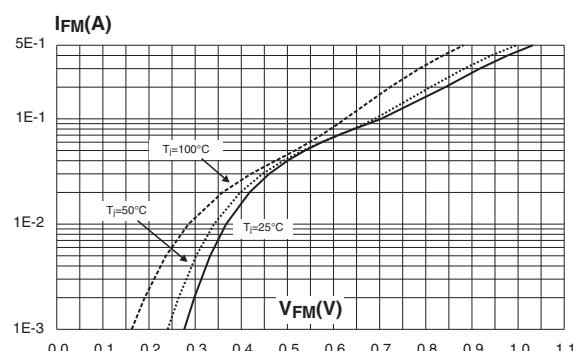
**Table 6: Dynamic Characteristics (T<sub>j</sub> = 25°C)**

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
C	Junction capacitance	T <sub>j</sub> = 25°C	V <sub>R</sub> = 1V	F = 1 MHz		7	pF
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 10 mA	I <sub>R</sub> = 10 mA			5	ns
η	Detection efficiency	C <sub>L</sub> = 300 pF	F = 45 MHz		80		%
		T <sub>j</sub> = 25°C	V <sub>i</sub> = 2 V	R <sub>L</sub> = 50 Ω			

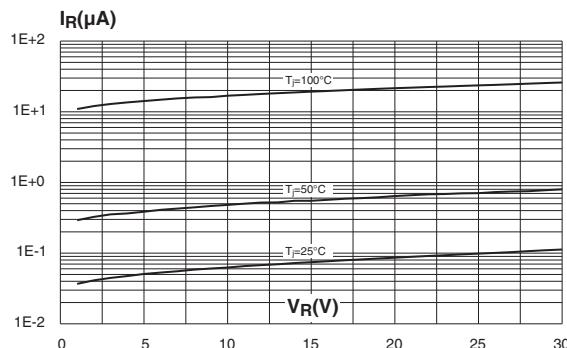
**Figure 1: Forward voltage drop versus forward current (typical values, low level)**



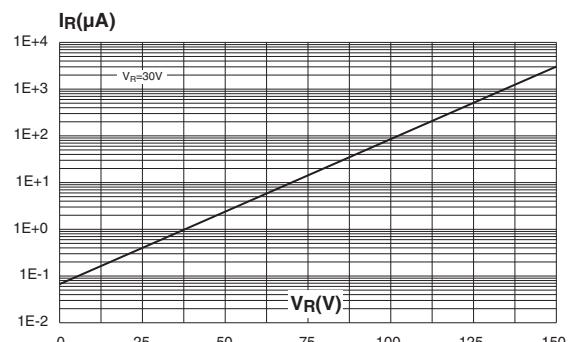
**Figure 2: Forward voltage drop versus forward current (typical values, high level)**



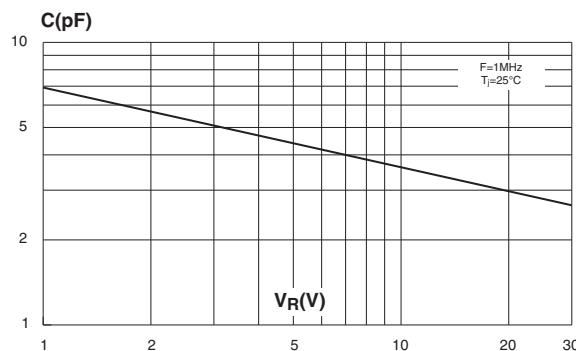
**Figure 3: Reverse leakage current versus reverse voltage applied (typical values)**



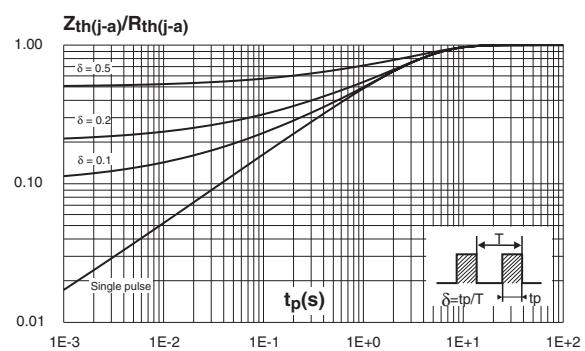
**Figure 4: Reverse leakage current versus junction temperature**



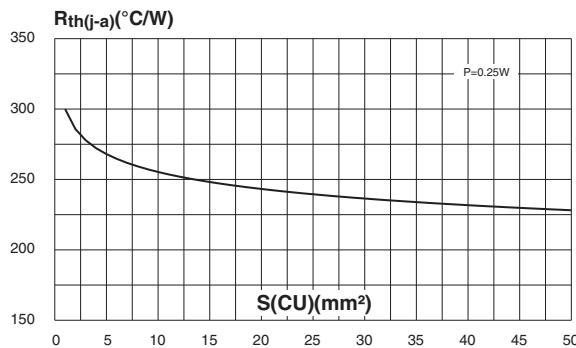
**Figure 5: Junction capacitance versus reverse voltage applied (typical values)**



**Figure 6: Relative variation of thermal impedance junction to ambient versus pulse duration (epoxy FR4 with recommended pad layout, e(Cu)=35μm)**

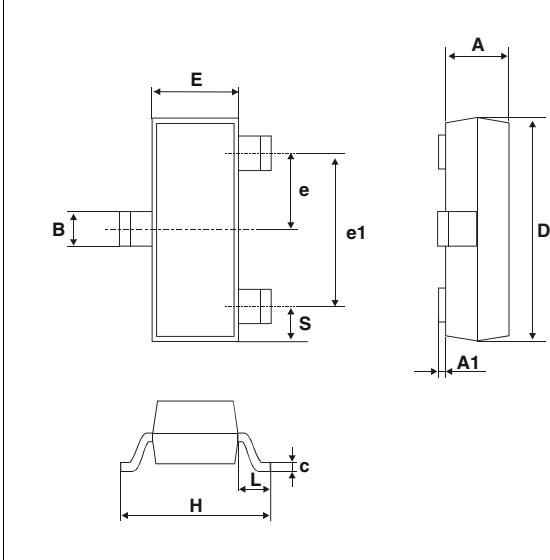


**Figure 7: Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, copper thickness: 35μm)**



## BAR42FILM / BAR43FILM

Figure 8: SOT23-3L Package Mechanical Data



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
c	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.6	0.047	0.063
H	2.1	2.75	0.083	0.108
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.014	0.026

Figure 9: Foot Print Dimensions (in millimeters)

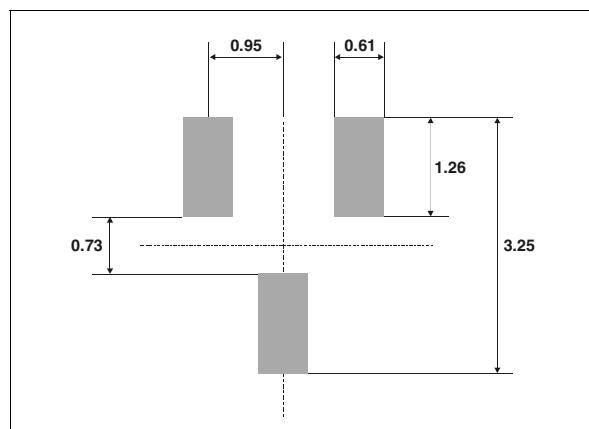


Table 7: Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
BAR42FILM	D94	SOT23-3L	0.01 g	3000	Tape & reel
BAR43FILM	D95				
BAR43AFILM	DB1				
BAR43CFILM	DB2				
BAR43SFILM	DA5				

- Epoxy meets UL94, V0

Table 8: Revision History

Date	Revision	Description of Changes
Aug-2001	2B	Last update.
16-Apr-2005	3	Layout update. No content change.

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